

Model Name: EBA37.5001-10

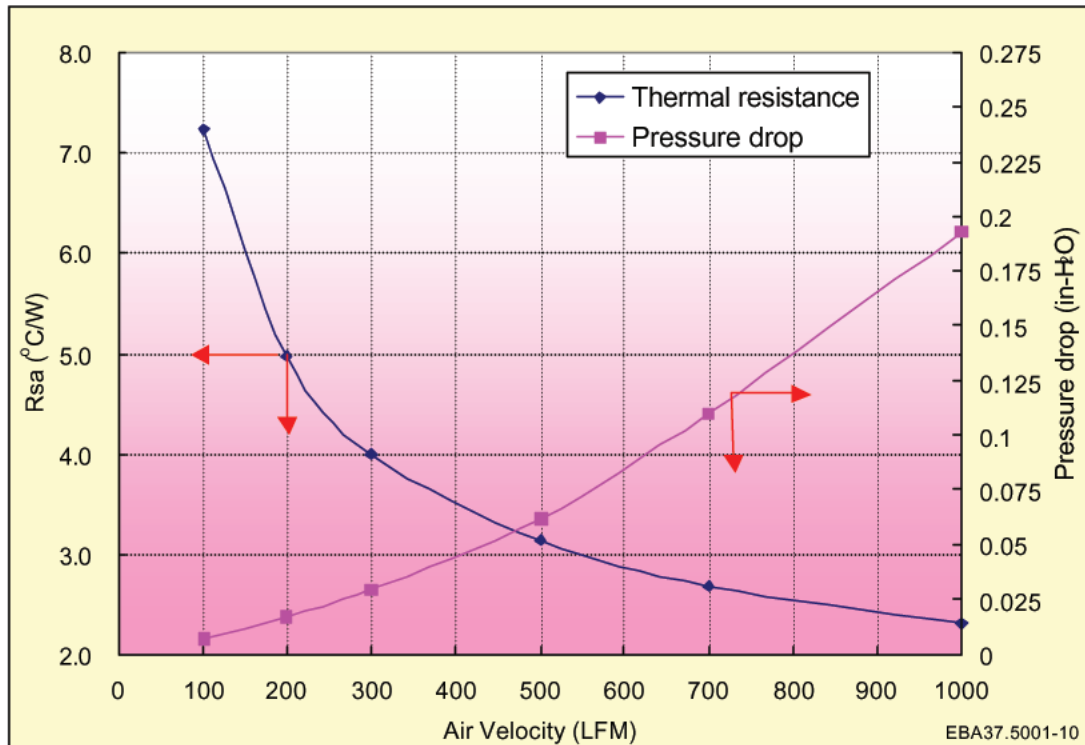
BGA Heat Sink For 37.5x37.5 Chip set

*Specification:

1. **Material:** Aluminum 6063
2. **Weight:** 14 gm
3. **Technology:** Extrusion
4. **Finish:** Black Anodize
5. **Heat Sink Dimension:**
37.2*37.2*9.8mm
6. **Copper package and Moulding compound package available**
7. **Heat Source size:** Uniform



*Performance Data:



AMERICAN THERMAL PRODUCTS

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